

Pin Description^[1]

Pin	Name	I/O	Type	Description
9	TCLK0	I, PD	LVC MOS	LVC MOS/LVTTL reference clock input
10	TCLK1	I, PU	LVC MOS	LVC MOS/LVTTL reference clock input
16, 18, 21, 23, 25	QA(4:0)	O	LVC MOS	Clock output bank A
32, 34, 36, 38, 40	QB(4:0)	O	LVC MOS	Clock output bank B
44, 46, 48, 50	QC(3:0)	O	LVC MOS	Clock output bank C
29	FB_OUT	O	LVC MOS	Feedback clock output. Connect to FB_IN for normal operation.
31	FB_IN	I, PU	LVC MOS	Feedback clock input. Connect to FB_OUT for normal operation. This input should be at the same voltage rail as input reference clock. See <i>Table 1</i> .
2	MR#/OE	I, PU	LVC MOS	Output enable/disable input. See <i>Table 2</i> .
3	CLK_STP#	I, PU	LVC MOS	Clock stop enable/disable input. See <i>Table 2</i> .
6	PLL_EN	I, PU	LVC MOS	PLL enable/disable input. See <i>Table 2</i> .
8	TCLK_SEL	I, PD	LVC MOS	Reference select input. See <i>Table 2</i> .
11, 52	VCO_SEL(1,0)	I, PD	LVC MOS	VCO divider select input. See <i>Tables 2, 3 and 4</i> .
7, 4, 5	SEL(A:C)	I, PD	LVC MOS	Frequency select input, Bank (A:C). See <i>Table 3</i> .
20, 14	FB_SEL(1,0)	I, PD	LVC MOS	Feedback dividers select inputs. See <i>Table 4</i> .
17, 22, 26	VDDQA	Supply	VDD	2.5V or 3.3V Power supply for bank A output clocks ^[2,3]
33, 37, 41	VDDQB	Supply	VDD	2.5V or 3.3V Power supply for bank B output clocks ^[2,3]
45, 49	VDDQC	Supply	VDD	2.5V or 3.3V Power supply for bank C output clocks ^[2,3]
28	VDDFB	Supply	VDD	2.5V or 3.3V Power supply for feedback output clock ^[2,3]
13	AVDD	Supply	VDD	2.5V or 3.3V Power supply for PLL ^[2,3]
12	VDD	Supply	VDD	2.5V or 3.3V Power supply for core and inputs ^[2,3]
15	AVSS	Supply	Ground	Analog Ground
1, 19, 24, 30, 35, 39, 43, 47, 51	VSS	Supply	Ground	Common Ground
27, 42	NC			No Connection

Notes:

1. PU = Internal pull-up, PD = Internal pull-down
2. A 0.1- μ F bypass capacitor should be placed as close as possible to each positive power pin (<0.2"). If these bypass capacitors are not close to the pins their high frequency filtering characteristics will be cancelled by the lead inductance of the traces.
3. AVDD and VDD pins must be connected to a power supply level that is at least equal or higher than that of VDDQA, VDDQB, VDDQC, and VDDFB power supply pins.

Table 1. Frequency Table

Feedback Output Divider	VCO	Input Frequency Range (AVDD = 3.3V)	Input Frequency Range (AVDD = 2.5V)
÷8	Input Clock * 8	25 MHz to 62.5 MHz	25 MHz to 50 MHz
÷12	Input Clock * 12	16.6 MHz to 41.6 MHz	16.6 MHz to 33.3 MHz
÷16	Input Clock * 16	12.5 MHz to 31.25 MHz	12.5 MHz to 25 MHz
÷24	Input Clock * 24	8.3 MHz to 20.8 MHz	8.3 MHz to 16.6 MHz
÷32	Input Clock * 32	6.25 MHz to 15.625 MHz	6.25 MHz to 12.5 MHz
÷48	Input Clock * 48	4.2 MHz to 10.4 MHz	4.2 MHz to 8.3 MHz
÷4	Input Clock * 4	50 MHz to 125 MHz	50 MHz to 100 MHz
÷6	Input Clock * 6	33.3 MHz to 83.3 MHz	33.3 MHz to 66.6 MHz
÷8	Input Clock * 8	25 MHz to 62.5 MHz	25 MHz to 50 MHz
÷12	Input Clock * 12	16.6 MHz to 41.6 MHz	16.6 MHz to 33.3 MHz

Table 2. Function Table (configuration controls)

Control	Default	0	1
TCLK_SEL	0	TCLK0	TCLK1
VCO_SEL0	0	VCO÷2 (mid input frequency range)	VCO÷4 (low input frequency range)
VCO_SEL1	0	Gated by VCO_SEL0	VCO (high input frequency range)
PLL_EN	1	Bypass mode, PLL disabled. The input clock connects to the output dividers	PLL enabled. The VCO output connects to the output dividers
MR#/OE	1	Outputs disabled (three-state) and reset of the device. During reset/output disable the PLL feedback loop is open and the VCO running at its minimum frequency. The device is reset by the internal power-on reset (POR) circuitry during power-up.	Outputs enabled
CLK_STP#	1	QA, QB, and QC outputs disabled in LOW state. FB_OUT is not affected by CLK_STP#.	Outputs enabled

Table 3. Function Table (Bank A, B, and C)

VCO_SEL1	VCO_SEL0	SELA	QA(4:0)	SELB	QB(4:0)	SELC	QC(3:0)
0	0	0	÷4	0	÷4	0	÷8
0	0	1	÷8	1	÷8	1	÷12
0	1	0	÷8	0	÷8	0	÷16
0	1	1	÷16	1	÷16	1	÷24
1	x	0	÷2	0	÷2	0	÷4
1	x	1	÷4	1	÷4	1	÷6

Table 4. Function Table (FB_OUT)

VCO_SEL1	VCO_SEL0	FB_SEL1	FB_SEL0	FB_OUT
0	0	0	0	+8
0	0	0	1	+16
0	0	1	0	+12
0	0	1	1	+24
0	1	0	0	+16
0	1	0	1	+32
0	1	1	0	+24
0	1	1	1	+48
1	x	0	0	+4
1	x	0	1	+8
1	x	1	0	+6
1	x	1	1	+12

Absolute Maximum Conditions

Parameter	Description	Condition	Min.	Max.	Unit
V _{DD}	DC Supply Voltage		-0.3	5.5	V
V _{DD}	DC Operating Voltage	Functional	2.375	3.465	V
V _{IN}	DC Input Voltage	Relative to V _{SS}	-0.3	V _{DD} + 0.3	V
V _{OUT}	DC Output Voltage	Relative to V _{SS}	-0.3	V _{DD} + 0.3	V
V _{TT}	Output termination Voltage		-	V _{DD} ÷ 2	V
LU	Latch Up Immunity	Functional	200	-	mA
R _{PS}	Power Supply Ripple	Ripple Frequency < 100 kHz	-	150	mVp-p
T _S	Temperature, Storage	Non Functional	-65	+150	°C
T _A	Temperature, Operating Ambient	Functional	-40	+85	°C
T _J	Temperature, Junction	Functional	-	150	°C
∅ _{JC}	Dissipation, Junction to Case	Functional	-	23	°C/W
∅ _{JA}	Dissipation, Junction to Ambient	Functional	-	55	°C/W
ESD _H	ESD Protection (Human Body Model)		2000	-	Volts
FIT	Failure in Time	Manufacturing test	10		ppm

DC Electrical Specifications ($V_{DD} = 3.3V \pm 5\%$, $T_A = -40^\circ C$ to $+85^\circ C$)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
V_{IL}	Input Voltage, Low	LVC MOS	–	–	0.8	V
V_{IH}	Input Voltage, High	LVC MOS	2.0	–	$V_{DD} + 0.3$	V
V_{OL}	Output Voltage, Low ^[4]	$I_{OL} = 24$ mA	–	–	0.55	V
		$I_{OL} = 12$ mA	–	–	0.30	
V_{OH}	Output Voltage, High ^[4]	$I_{OH} = -24$ mA	2.4	–	–	V
I_{IL}	Input Current, Low ^[5]	$V_{IL} = V_{SS}$	–	–	-100	μA
I_{IH}	Input Current, High ^[5]	$V_{IL} = V_{DD}$	–	–	100	μA
I_{DDA}	PLL Supply Current	A_{VDD} only	–	5	10	mA
I_{DDQ}	Quiescent Supply Current	All V_{DD} pins except A_{VDD}	–	–	1	mA
I_{DD}	Dynamic Supply Current	Outputs loaded @ 100 MHz	–	225	–	mA
		Outputs loaded @ 200 MHz	–	290	–	
C_{IN}	Input Pin Capacitance		–	4	–	pF
Z_{OUT}	Output Impedance		12	15	18	Ω

DC Electrical Specifications ($V_{DD} = 2.5V \pm 5\%$, $T_A = -40^\circ C$ to $+85^\circ C$)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
V_{IL}	Input Voltage, Low	LVC MOS	–	–	0.7	V
V_{IH}	Input Voltage, High	LVC MOS	1.7	–	$V_{DD} + 0.3$	V
V_{OL}	Output Voltage, Low ^[4]	$I_{OL} = 15$ mA	–	–	0.6	V
V_{OH}	Output Voltage, High ^[4]	$I_{OH} = -15$ mA	1.8	–	–	V
I_{IL}	Input Current, Low ^[5]	$V_{IL} = V_{SS}$	–	–	-100	μA
I_{IH}	Input Current, High ^[5]	$V_{IL} = V_{DD}$	–	–	100	μA
I_{DDA}	PLL Supply Current	A_{VDD} only	–	5	10	mA
I_{DDQ}	Quiescent Supply Current	All V_{DD} pins except A_{VDD}	–	–	1	mA
I_{DD}	Dynamic Supply Current	Outputs loaded @ 100 MHz	–	135	–	mA
		Outputs loaded @ 200 MHz	–	160	–	
C_{IN}	Input Pin Capacitance		–	4	–	pF
Z_{OUT}	Output Impedance		14	18	22	Ω

Notes:

- Driving one 50 Ω parallel terminated transmission line to a termination voltage of V_{TT} . Alternatively, each output drives up to two 50 Ω series terminated transmission lines.
- Inputs have pull-up or pull-down resistors that affect the input current.

AC Electrical Specifications^[6] ($V_{DD} = 2.5V \pm 5\%$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
f_{VCO}	VCO Frequency		200	–	400	MHz
f_{in}	Input Frequency	÷4 Feedback	50	–	100	MHz
		÷6 Feedback	33.3	–	66.6	
		÷8 Feedback	25	–	50	
		÷12 Feedback	16.7	–	33.3	
		÷16 Feedback	12.5	–	25	
		÷24 Feedback	8.3	–	16.7	
		÷32 Feedback	6.3	–	12.5	
		÷48 Feedback	4.2	–	8.3	
		Bypass mode (PLL_EN = 0)	0	–	200	
f_{refDC}	Input Duty Cycle		25	–	75	%
t_r, t_f	TCLK Input Rise/FallTime	0.7V to 1.7V	–	–	1.0	ns
f_{MAX}	Maximum Output Frequency	÷2 Output	100	–	200	MHz
		÷4 Output	50	–	100	
		÷6 Output	33.3	–	66.6	
		÷8 Output	25	–	50	
		÷12 Output	16.7	–	33.3	
		÷16 Output	12.5	–	25	
		÷24 Output	8.3	–	16.7	
DC	Output Duty Cycle		45	–	55	%
t_r, t_f	Output Rise/Fall times	0.7V to 1.8V	0.1	–	1.0	ns
$t_{(\phi)}$	Propagation Delay (static phase offset)	TCLK to FB_IN, does not include jitter	–100	–	100	ps
$t_{sk(O)}$	Output-to-Output Skew	Skew within Bank	–	–	150	ps
tsk(B)	Bank-to-Bank Skew	Banks at same frequency	–	–	150	ps
		Banks at different frequency	–	–	225	
$t_{PLZ, HZ}$	Output Disable Time		–	–	10	ns
$t_{PZL, ZH}$	Output Enable Time		–	–	10	ns
BW	PLL Closed Loop Bandwidth (–3 dB)	VCO_SEL = 0	–	0.5 - 1.0	–	MHz
		VCO_SEL = 1	–	1.0 - 2.0	–	
$t_{JIT(CC)}$	Cycle-to-Cycle Jitter	Same frequency	–	–	150	ps
		Multiple frequencies	–	–	300	
$t_{JIT(PER)}$	Period Jitter		–	–	100	ps
$t_{JIT(\phi)}$	I/O Phase Jitter		–	–	150	ps
t_{LOCK}	Maximum PLL Lock Time		–	–	1	ms

Note:

6. AC characteristics apply for parallel output termination of 50Ω to V_{TT} . Parameters are guaranteed by characterization and are not 100% tested.

AC Electrical Specifications ^[6] ($V_{DD} = 3.3V \pm 5\%$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
f_{VCO}	VCO Frequency		200	–	500	MHz
f_{in}	Input Frequency	÷4 Feedback	50	–	125	MHz
		÷6 Feedback	33.3	–	83.3	
		÷8 Feedback	25	–	62.5	
		÷12 Feedback	16.7	–	41.6	
		÷16 Feedback	12.5	–	31.3	
		÷24 Feedback	8.3	–	20.8	
		÷32 Feedback	6.3	–	15.6	
		÷48 Feedback	4.2	–	10.4	
		Bypass mode (PLL_EN = 0)	0	–	200	
f_{refDC}	Input Duty Cycle		25	–	75	%
t_r, t_f	TCLK Input Rise/FallTime	0.8V to 2.0V	–	–	1.0	ns
f_{MAX}	Maximum Output Frequency	÷2 Output	100	–	200	MHz
		÷4 Output	50	–	125	
		÷6 Output	33.3	–	83.3	
		÷8 Output	25	–	62.5	
		÷12 Output	16.7	–	41.6	
		÷16 Output	12.5	–	31.3	
		÷24 Output	8.3	–	20.8	
DC	Output Duty Cycle		45	–	55	%
t_r, t_f	Output Rise/Fall times	0.8V to 2.4V	0.1	–	1.0	ns
$t_{(\phi)}$	Propagation Delay (static phase offset)	TCLK to FB_IN, same V_{DD} , does not include jitter	–100	–	100	ps
$t_{sk(O)}$	Output-to-Output Skew	Skew within Bank	–	–	150	ps
tsk(B)	Bank-to-Bank Skew	Banks at same voltage, same frequency	–	–	150	ps
		Banks at same voltage, different frequency	–	–	225	
		Banks at different voltage	–	–	250	
$t_{PLZ, HZ}$	Output Disable Time		–	–	10	ns
$t_{PZL, ZH}$	Output Enable Time		–	–	10	ns
BW	PLL Closed Loop Bandwidth (–3dB)	VCO_SEL = 0	–	0.5 - 1.0	–	MHz
		VCO_SEL = 1	–	1.0 - 2.0	–	
$t_{JIT(CC)}$	Cycle-to-Cycle Jitter	Same frequency	–	–	150	ps
		Multiple frequencies	–	–	300	
$t_{JIT(PER)}$	Period Jitter		–	–	100	ps
$t_{JIT(\phi)}$	I/O Phase Jitter	I/O at same V_{DD}	–	–	150	ps
t_{LOCK}	Maximum PLL Lock Time		–	–	1	ms

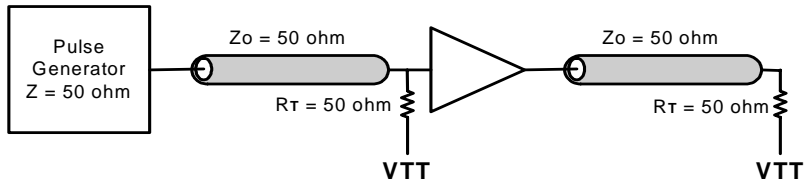


Figure 1. AC Test Reference for $V_{DD} = 3.3V / 2.5V$

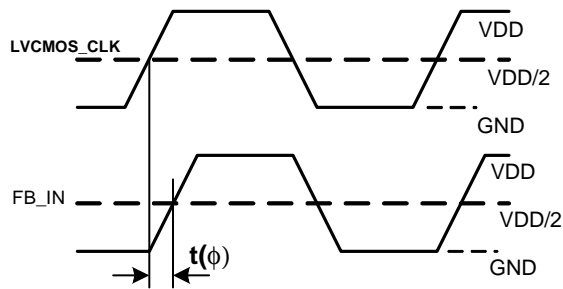


Figure 2. Propagation Delay $t(\phi)$, Static Phase Offset

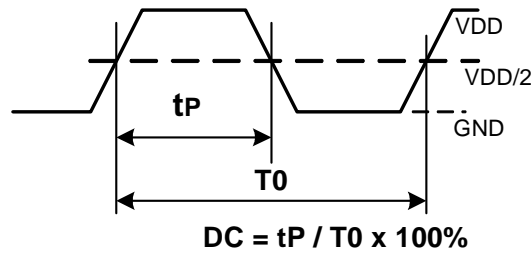


Figure 3. Output Duty Cycle (DC)

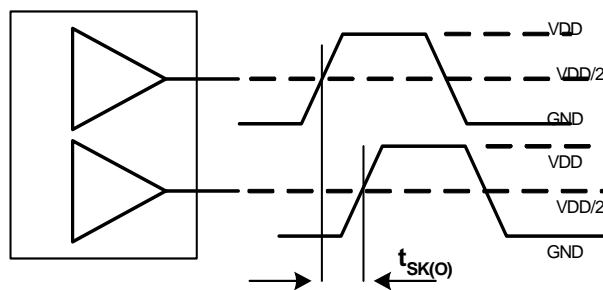
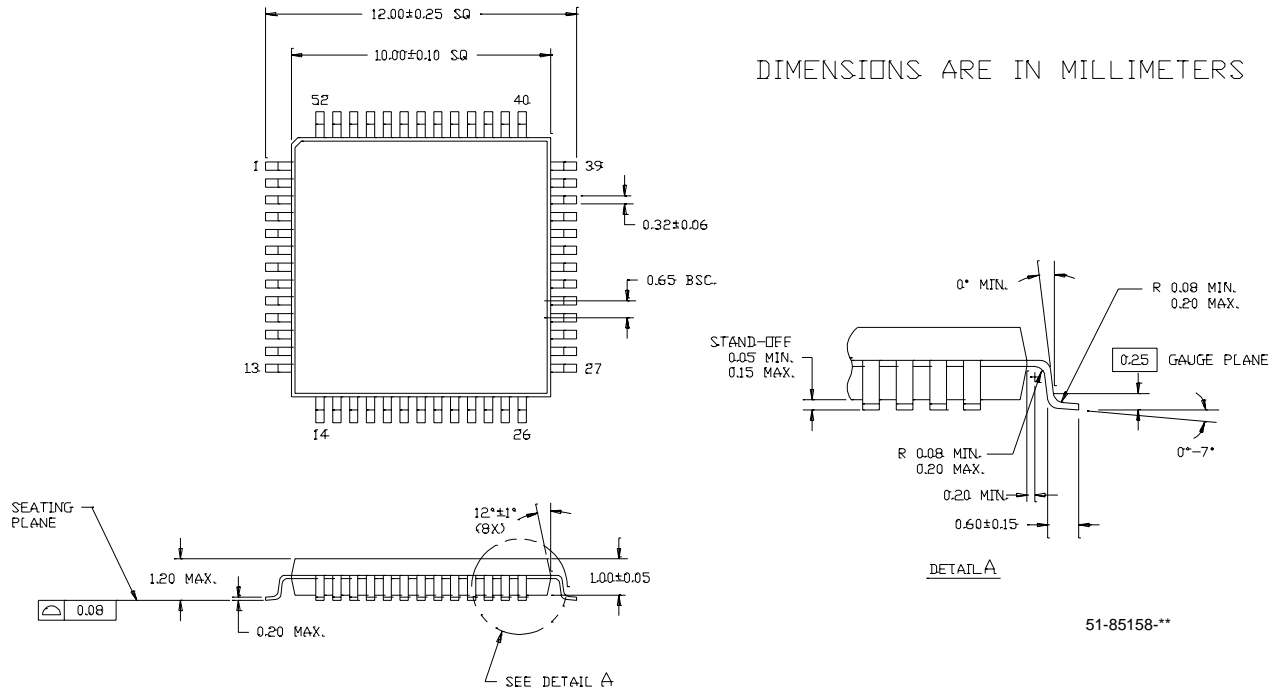


Figure 4. Output-to-Output Skew, $t_{sk(o)}$

Ordering Information

Part Number	Package Type	Product Flow
CY29775AI	52-pin TQFP	Industrial, -40°C to +85°C
CY29775AIT	52-pin TQFP -Tape and Reel	Industrial, -40°C to 85°C

Package Drawing and Dimension
52-Lead Thin Plastic Quad Flat Pack (10 x 10 x 1.0 mm) A52B


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Document History Page

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Rev.	ECN No.	Issue Date	Orig. of Change	Description of Change
**	125955	04/29/03	RGL	New Data Sheet